


# NX138AKS

## 60 V, dual N-channel Trench MOSFET

15 June 2016 Product data sheet

## 1. General description

Dual N-channel enhancement mode Field-Effect Transistor (FET) in a very small SOT363 (SC-88) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Low threshold voltage
- Very fast switching
- Trench MOSFET technology
- ElectroStatic Discharge (ESD) protection

## 3. Applications

- Relay driver
- High-speed line driver
- Low-side loadswitch
- Switching circuits

## 4. Quick reference data

**Table 1. Quick reference data**

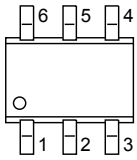
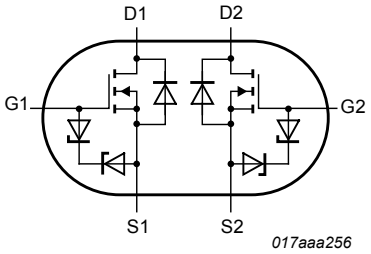
| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| **Per transistor** | | | | | | | |
| $V_{DS}$ | drain-source voltage | $T_j$ = 25 °C | | - | - | 60 | V |
| $V_{GS}$ | gate-source voltage | | | -20 | - | 20 | V |
| $I_D$ | drain current | $V_{GS}$ = 10 V; $T_{amb}$ = 25 °C | [1] | - | - | 170 | mA |
| **Static characteristics (per transistor)** | | | | | | | |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = 10 V; $I_D$ = 170 mA; $T_j$ = 25 °C | | - | 3 | 4.5 | Ω |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 1 $cm^2$.

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## 5. Pinning information

**Table 2. Pinning information**

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|---|---|---|---|---|
| 1 | S1 | source TR1 |  TSSOP6 (SOT363) |  |
| 2 | G1 | gate TR1 | | |
| 3 | D2 | drain TR2 | | |
| 4 | S2 | source TR2 | | |
| 5 | G2 | gate TR2 | | |
| 6 | D1 | drain TR1 | | |

## 6. Ordering information

**Table 3. Ordering information**

| Type number | Package | | |
|---|---|---|---|
| | Name | Description | Version |
| NX138AKS | TSSOP6 | plastic surface-mounted package; 6 leads | SOT363 |

## 7. Marking

**Table 4. Marking codes**

| Type number | Marking code [1] |
|---|---|
| NX138AKS | F8% |

[1] % = placeholder for manufacturing site code


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# 8. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---|---|---|---|---|---|---|
| **Per transistor** | | | | | | |
| $V_{DS}$ | drain-source voltage | $T_j$ = 25 °C | | - | 60 | V |
| $V_{GS}$ | gate-source voltage | | | -20 | 20 | V |
| $I_D$ | drain current | $V_{GS}$ = 10 V; $T_{amb}$ = 25 °C | [1] | - | 170 | mA |
| | | $V_{GS}$ = 10 V; $T_{amb}$ = 100 °C | [1] | - | 110 | mA |
| $I_{DM}$ | peak drain current | $T_{amb}$ = 25 °C; single pulse; $t_p \leq 10$ µs | | - | 680 | mA |
| $P_{tot}$ | total power dissipation | $T_{amb}$ = 25 °C | [2] | - | 265 | mW |
| | | | [1] | - | 325 | mW |
| | | $T_{sp}$ = 25 °C | | - | 1.33 | W |
| **Per device** | | | | | | |
| $T_j$ | junction temperature | | | -55 | 150 | °C |
| $T_{amb}$ | ambient temperature | | | -55 | 150 | °C |
| $T_{stg}$ | storage temperature | | | -65 | 150 | °C |
| **Source-drain diode** | | | | | | |
| $I_S$ | source current | $T_{amb}$ = 25 °C | [1] | - | 170 | mA |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 1 $cm^2$.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.


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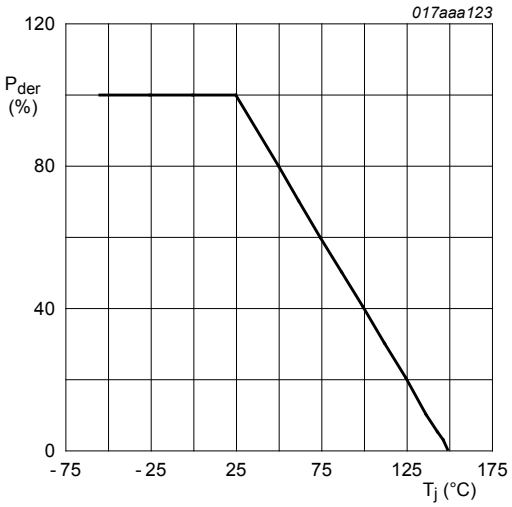



**Fig. 1. MOSFET transistor: Normalized total power dissipation as a function of junction temperature**

$$P_{der} = \frac{P_{tot}}{P_{tot(25°C)}} \times 100\ \%$$

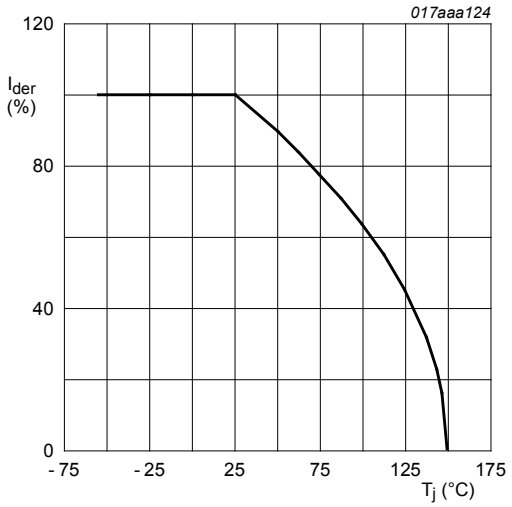
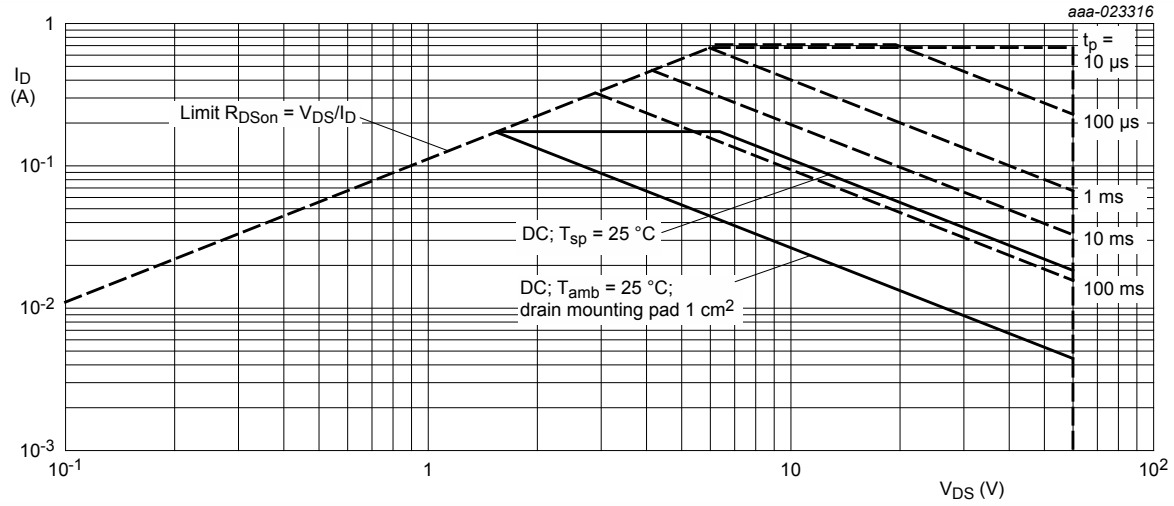



**Fig. 2. MOSFET transistor: Normalized continuous drain current as a function of junction temperature**

$$I_{der} = \frac{I_D}{I_{D(25°C)}} \times 100\ \%$$




$I_{DM}$ = single pulse

**Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage**


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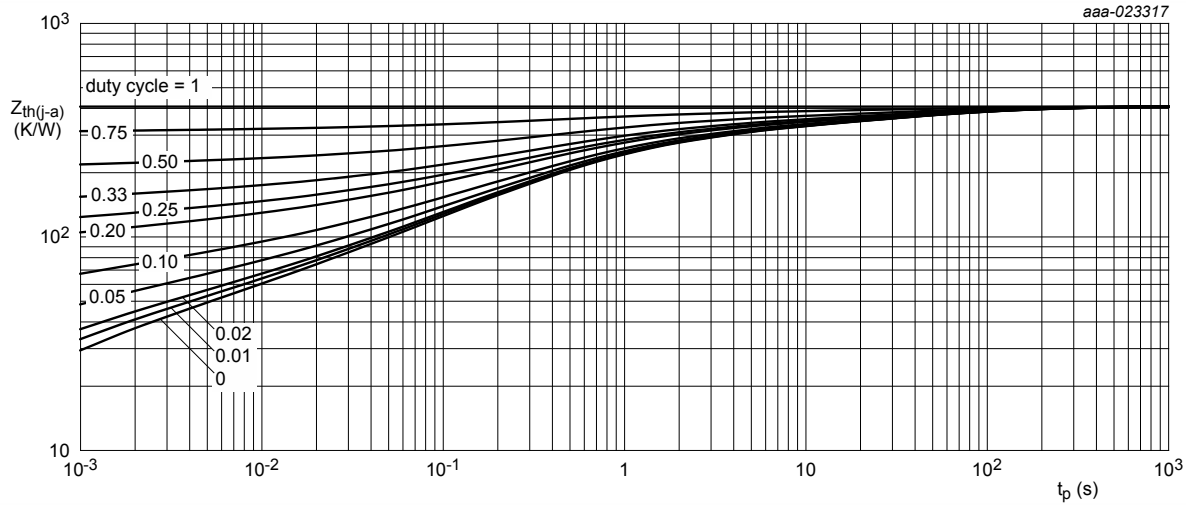
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# 9. Thermal characteristics

**Table 6. Thermal characteristics**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| **Per transistor** | | | | | | | |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | 500 | 560 | K/W |
| | | | [2] | - | 450 | 480 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | | - | 100 | 115 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 $cm^2$.

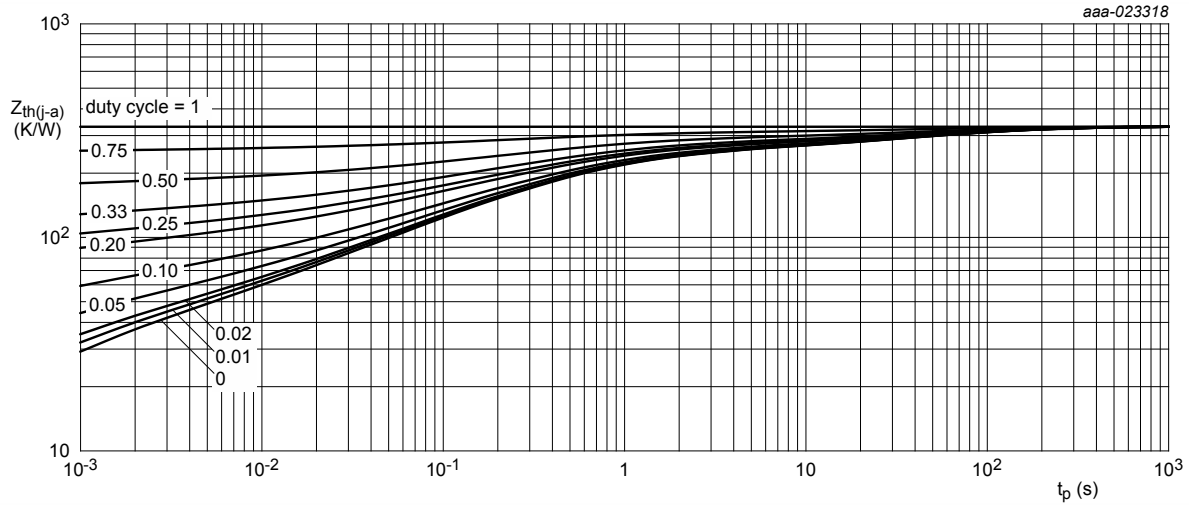



FR4 PCB, standard footprint

**Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**


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FR4 PCB, mounting pad for drain 1 $cm^2$

**Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**


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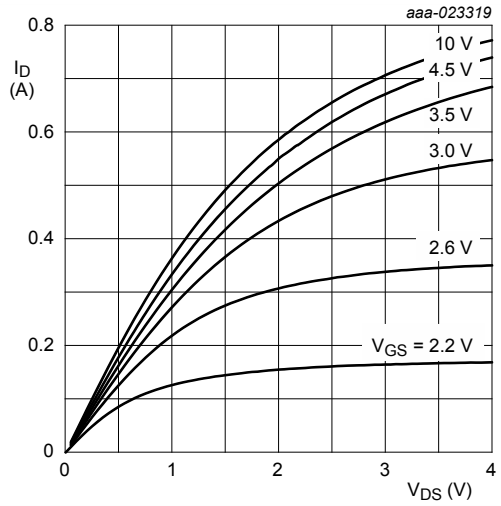
# 10. Characteristics

**Table 7. Characteristics**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| **Static characteristics (per transistor)** | | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | 60 | - | - | V |
| $V_{GSth}$ | gate-source threshold voltage | $I_D$ = 250 µA; $V_{DS}$=$V_{GS}$; $T_j$ = 25 °C | | 0.8 | 1.1 | 1.5 | V |
| $I_{DSS}$ | drain leakage current | $V_{DS}$ = 60 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | - | 1 | µA |
| $I_{GSS}$ | gate leakage current | $V_{GS}$ = 20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | 2 | µA |
| | | $V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | -2 | µA |
| | | $V_{GS}$ = 10 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | 0.5 | µA |
| | | $V_{GS}$ = -10 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | -0.5 | µA |
| | | $V_{GS}$ = 5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | 100 | nA |
| | | $V_{GS}$ = -5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | -100 | nA |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = 10 V; $I_D$ = 170 mA; $T_j$ = 25 °C | | - | 3 | 4.5 | Ω |
| | | $V_{GS}$ = 10 V; $I_D$ = 170 mA; $T_j$ = 150 °C | | - | 6 | 9 | Ω |
| | | $V_{GS}$ = 5 V; $I_D$ = 150 mA; $T_j$ = 25 °C | | - | 3.7 | 5.2 | Ω |
| | | $V_{GS}$ = 4 V; $I_D$ = 130 mA; $T_j$ = 25 °C | | - | 4 | 6.3 | Ω |
| | | $V_{GS}$ = 2.5 V; $I_D$ = 100 A; $T_j$ = 25 °C | | - | 5 | 10 | Ω |
| $g_{fs}$ | forward transconductance | $V_{DS}$ = 10 V; $I_D$ = 170 mA; $T_j$ = 25 °C | | - | 3.5 | - | S |
| **Dynamic characteristics (per transistor)** | | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $V_{DS}$ = 30 V; $I_D$ = 170 mA; $V_{GS}$ = 10 V; $T_j$ = 25 °C | | - | 0.9 | 1.4 | nC |
| $Q_{GS}$ | gate-source charge | | | - | 0.1 | - | nC |
| $Q_{GD}$ | gate-drain charge | | | - | 0.2 | - | nC |
| $C_{iss}$ | input capacitance | $V_{DS}$ = 30 V; f = 1 MHz; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | 15 | 20 | pF |
| $C_{oss}$ | output capacitance | | | - | 2.3 | - | pF |
| $C_{rss}$ | reverse transfer capacitance | | | - | 1.5 | - | pF |
| $t_{d(on)}$ | turn-on delay time | $V_{DS}$ = 30 V; $I_D$ = 170 mA; $V_{GS}$ = 10 V; $R_{G(ext)}$ = 75 Ω; $T_j$ = 25 °C | | - | 8 | 12 | ns |
| $t_r$ | rise time | | | - | 10 | - | ns |
| $t_{d(off)}$ | turn-off delay time | | | - | 8 | 20 | ns |
| $t_f$ | fall time | | | - | 5 | - | ns |
| **Source-drain diode (per transistor)** | | | | | | | |
| $V_{SD}$ | source-drain voltage | $I_S$ = 170 mA; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | 0.8 | 1.2 | V |

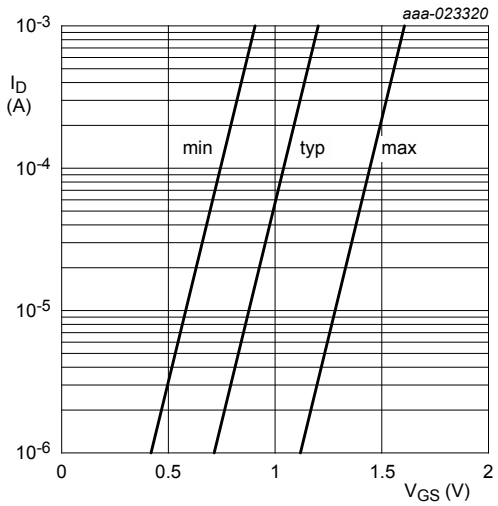

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$T_j$ = 25 °C

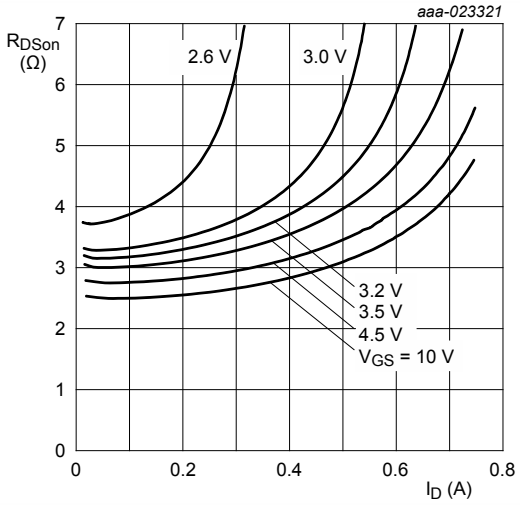
**Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values**




$V_{DS}$ = 5 V

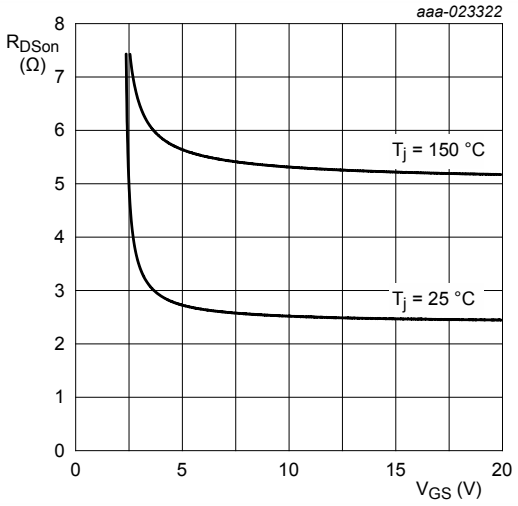
$T_j$ = 25 °C

**Fig. 7. Sub-threshold drain current as a function of gate-source voltage**




$T_j$ = 25 °C

**Fig. 8. Drain-source on-state resistance as a function of drain current; typical values**

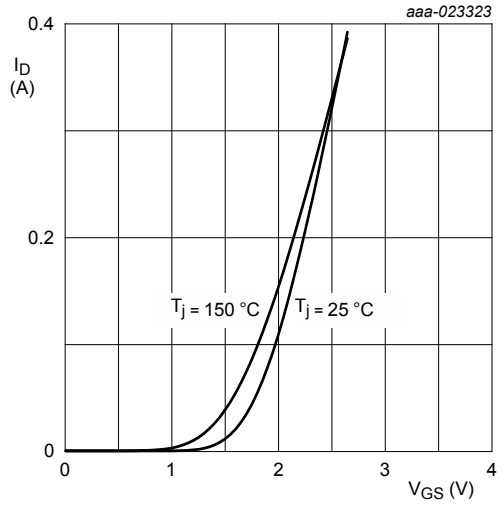



$I_D$ = 0.2 A

**Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values**


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$V_{DS} > I_D \times R_{DSon}$

**Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values**

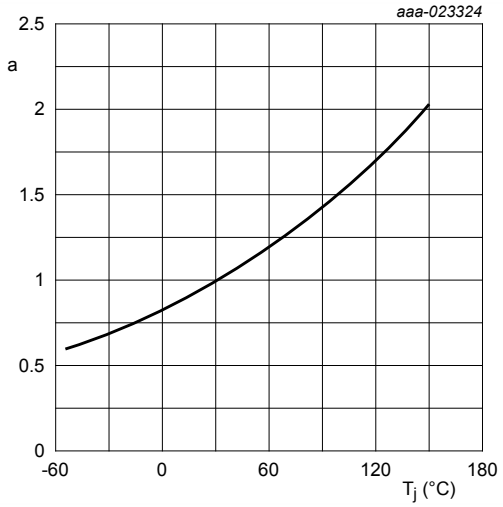
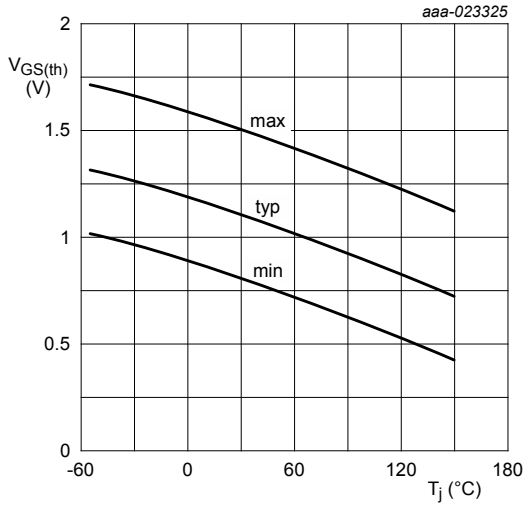


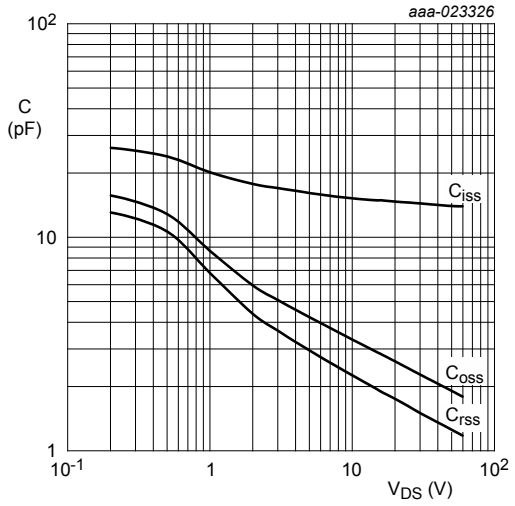

**Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values**

$$a = \frac{R_{DSon}}{R_{DSon(25\,°C)}}$$




$I_D$ = 250 µA; $V_{DS} = V_{GS}$

**Fig. 12. Gate-source threshold voltage as a function of junction temperature**

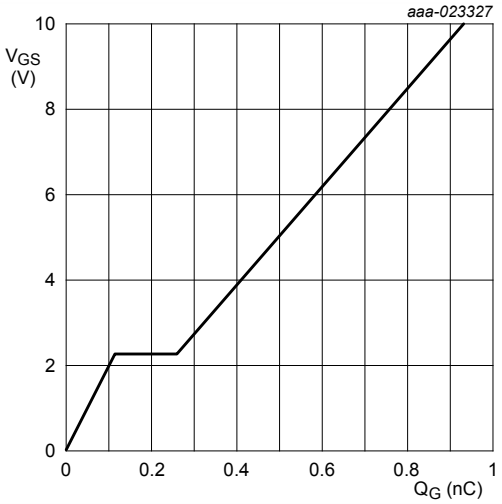



f = 1 MHz; $V_{GS}$ = 0 V

**Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values**


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$V_{DS}$ = 30 V; $I_D$ = 0.9 A

**Fig. 14. Gate-source voltage as a function of gate charge; typical values**

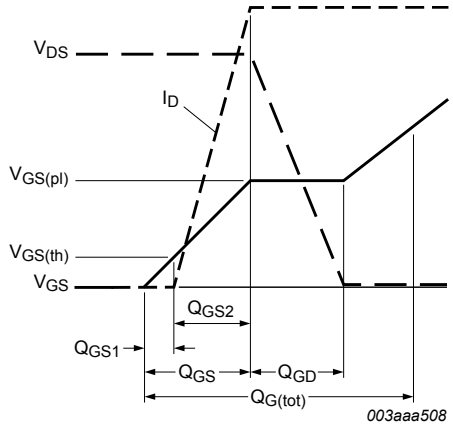
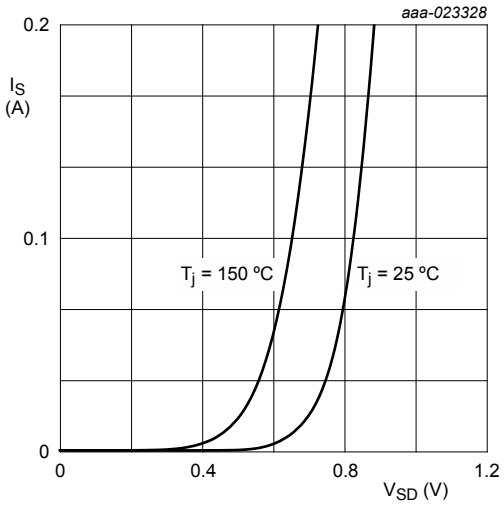



**Fig. 15. MOSFET transistor: Gate charge waveform definitions**




$V_{GS}$ = 0 V

**Fig. 16. Source current as a function of source-drain voltage; typical values**

## 11. Test information

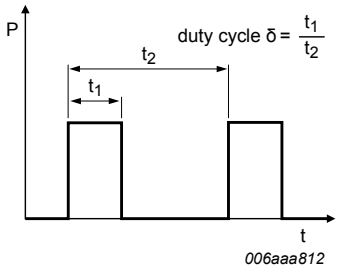


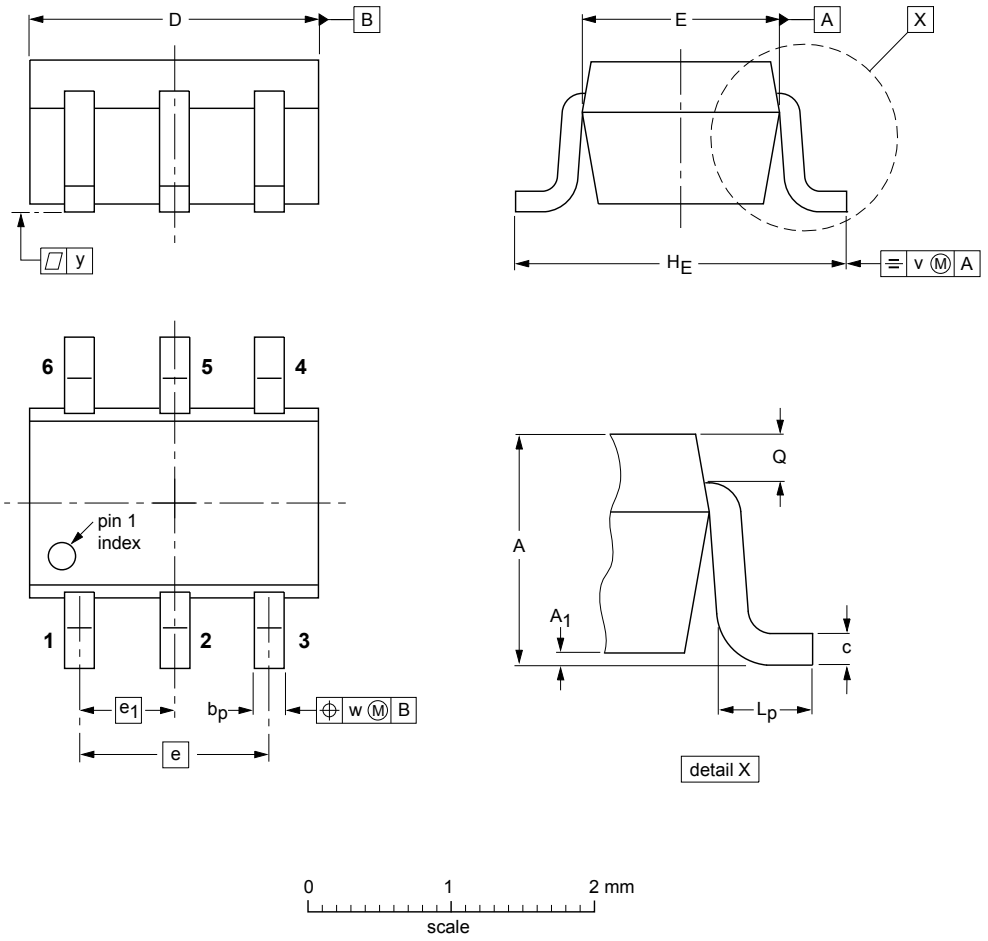

**Fig. 17. Duty cycle definition**


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## 12. Package outline

**Plastic surface-mounted package; 6 leads** **SOT363**




**DIMENSIONS (mm are the original dimensions)**

| UNIT | A | $A_1$ max | $b_p$ | c | D | E | e | $e_1$ | $H_E$ | $L_p$ | Q | v | w | y |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | 1.1<br>0.8 | 0.1 | 0.30<br>0.20 | 0.25<br>0.10 | 2.2<br>1.8 | 1.35<br>1.15 | 1.3 | 0.65 | 2.2<br>2.0 | 0.45<br>0.15 | 0.25<br>0.15 | 0.2 | 0.2 | 0.1 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT363 | | | SC-88 | | | ~~04-11-08~~<br>06-03-16 |

**Fig. 18. Package outline TSSOP6 (SOT363)**


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## 13. Soldering

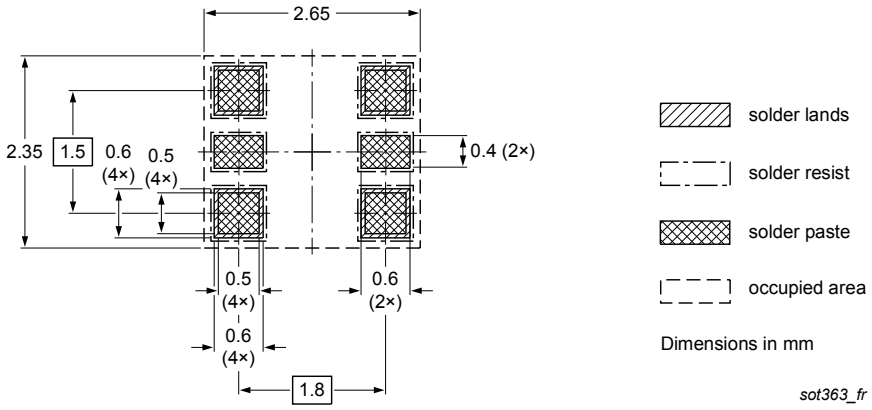



**Fig. 19. Reflow soldering footprint for TSSOP6 (SOT363)**

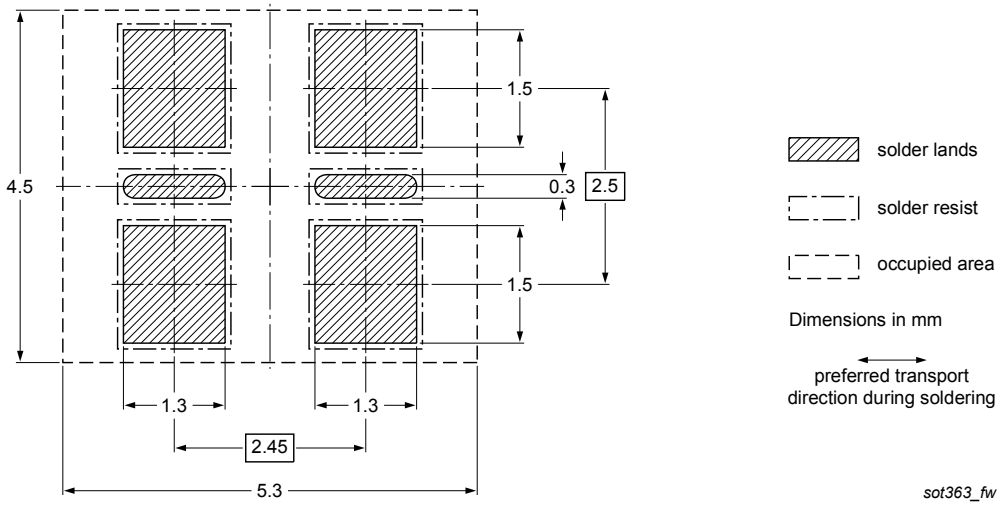



**Fig. 20. Wave soldering footprint for TSSOP6 (SOT363)**


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# 14. Revision history

**Table 8. Revision history**

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|---|---|---|---|---|
| NX138AKS v.1 | 20160615 | Product data sheet | - | - |


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# 15. Legal information

## 15.1 Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|---|---|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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